

25. The composition of claim 24, wherein said resorcinol formaldehyde latex has a formaldehyde to resorcinol mole ratio of from about 1.2 to 2.
26. The composition of claim 25, wherein said resorcinol formaldehyde latex has a latex to resorcinol formaldehyde ratio, based on a dry weight, is about 4.25 to 4.75.
27. The composition of claim 24, wherein said epoxy is a sorbitol epoxy.
28. The composition of claim 24, wherein said epoxy is in a range of about 3 to 8 weight % on a dry weight basis.
29. The composition of claim 24, wherein said epoxy is in a range of about 4 to 5 weight % on a dry weight basis.
30. The composition of claim 24, wherein said alkali is sodium hydroxide.
31. The single dip composition, consisting of: from about 2 to 12 weight % epoxy resin, sufficient alkali additive to buffer the composition, and resorcinol formaldehyde latex based on a dry weight basis.
32. The composition of claim 31, wherein said alkali additive is sodium hydroxide.

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**REMARKS**

In the parent application there was a Restriction Requirement between Invention I directed to claims 1 – 11 drawn to a single dip adhesive composition and Invention II relative to claims 12 – 23 drawn to a coated polyester cord and a rubber composite. Later, the Examiner issued a second restriction requirement against claims 1 – 11 asking for a restriction to claims 1 – 7 versus claims 8 – 11. Each of the non-elected species and inventions set forth in Parent Application No. 09/754,859 dated January 4, 2001 continues with this application although such